## ASSP <br> Single Serial Input PLL Frequency Synthesizer <br> On-Chip 2.5 GHz Prescaler <br> MB15E07

## DESCRIPTION

The Fujitsu MB15E07 is serial input Phase Locked Loop (PLL) frequency synthesizer with a 2.5 GHz prescaler. A $32 / 33$ or a $64 / 65$ can be selected for the prescaler that enables pulse swallow operation.
The latest BiCMOS process technology is used, resultantly a supply current is limited as low as 8 mA typ. This operates with a supply voltage of 3.0 V (typ.)
Furthermore, a super charger circuit is included to get a fast tuning as well as low noise performance. As a result of this, MB15E07 is ideally suitable for digital mobile communications, such as GSM (Global System for Mobile Communications).

## ■ FEATURES

- High frequency operation: $2.5 \mathrm{GHz} \max (@ \mathrm{P}=64 / 65)$

> 1.8 GHz max (@P = 32/33)

- Low power supply voltage: $\mathrm{Vcc}=2.7$ to 3.6 V
- Very Low power supply current : Icc $=8.0 \mathrm{~mA}$ typ. (Vcc $=3 \mathrm{~V}$ )
- Power saving function : lps = $0.1 \mu \mathrm{~A}$ typ.
- Pulse swallow function: $32 / 33$ or 64/65
- Serial input 14-bit programmable reference divider: $R=5$ to 16,383
- Serial input 18 -bit programmable divider consisting of:
- Binary 7-bit swallow counter: 0 to 127
- Binary 11-bit programmable counter: 5 to 2,047
- Wide operating temperature: $\mathrm{Ta}=-40$ to $85^{\circ} \mathrm{C}$
- Plastic 16-pin SSOP package (FPT-16P-M05)


## PACKAGE


(FPT-16P-M05)

PIN ASSIGNMENT


## PIN DESCRIPTIONS

| Pin no. | Pin name | I/O | Descriptions |
| :---: | :---: | :---: | :--- |
| 1 | OSCIN | I | Programmable reference divider input. <br> Oscillator input. <br> Connection for an crystal or a TCXO. <br> TCXO should be connected with a coupling capacitor. |
| 2 | OSCout | O | Oscillator output. <br> Connection for an external crystal. |
| 3 | $V_{P}$ | - | Power supply voltage input for the charge pump. |$|$| 4 | Vcc | - |
| :---: | :---: | :--- |
| Power supply voltage input. |  |  |

## BLOCK DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Rating | Unit | Remark |
| :--- | :---: | :---: | :---: | :---: |
| Power supply voltage | $\mathrm{V}_{\mathrm{cc}}$ | -0.5 to +4.0 | V |  |
|  | $\mathrm{~V}_{\mathrm{P}}$ | $\mathrm{V}_{\mathrm{cc}}$ to +6.0 | V |  |
| Input voltage | $\mathrm{V}_{\mathrm{l}}$ | -0.5 to $\mathrm{Vcc}+0.5$ | V |  |
| Output voltage | $\mathrm{V}_{\mathrm{c}}$ | -0.5 to $\mathrm{Vcc}+0.5$ | V |  |
| Storage temperature | $\mathrm{T}_{\mathrm{stg}}$ | -55 to +125 | ${ }^{\circ} \mathrm{C}$ |  |

Note: Permanent device damage may occur if the above Absolute Maximum Ratings are exceeded. Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | Value |  |  | Unit | Remark |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |
| Power supply voltage | $\mathrm{V}_{\mathrm{cc}}$ | 2.7 | 3.0 | 3.6 | V |  |
|  | $\mathrm{~V}_{\mathrm{P}}$ | V cc | - | 6.0 | V |  |
| Input voltage | $\mathrm{V}_{\mathrm{c}}$ | GND | - | $\mathrm{V}_{\mathrm{cc}}$ | V |  |
| Operating temperature | Ta | -40 | - | +85 | ${ }^{\circ} \mathrm{C}$ |  |

## Handling Precautions

- This device should be transported and stores in anti-static containers.
- This is a static-sensitive device; take proper anti-ESD precautions. Ensure that personnel and equipment are properly grounded. Cover workbenches with grounded conductive mats.
- Always turn the power supply off before inserting or removing the device from its socket.
- Protect leads with a conductive sheet when handling or transporting PC boards with devices.


## ELECTRICAL CHARACTERISTICS

| Parameter |  | Symbol | Condition | $\left(\mathrm{Vcc}=2.7\right.$ to $3.6 \mathrm{~V}, \mathrm{Ta}=-40$ to $\left.+85^{\circ} \mathrm{C}\right)$ |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Value |  | Unit |
|  |  | Min. |  |  | Typ. | Max. |
| Power supply current*1 |  |  | Icc | $\begin{aligned} & \text { fin }=1800 \mathrm{MHz}, \\ & \text { fosc }=12 \mathrm{MHz}, \mathrm{P}=32 / 33 \end{aligned}$ | - | 8.0 | - | mA |
| Power saving current |  |  | Ips | ZC = "H" or open | - | 0.1 | 10 | $\mu \mathrm{A}$ |
| Operating frequency |  | fin | $\mathrm{P}=32 / 33$ | 100 | - | 1800 | MHz |
|  |  | $\mathrm{P}=64 / 65$ | 100 | - | 2500 | MHz |
| Crystal oscillator operating frequency |  |  | fosc | min. $500 \mathrm{mVp}-\mathrm{p}$ | 3 | - | 40 | MHz |
| Input sensitivity | fin | Vfin | $50 \Omega$ system (Refer to the test circuit.) | -10 | - | +2 | dBm |
|  | OSCin | Vosc |  | 500 | - | Vcc | mVp-p |
| Input voltage | Data, Clock, LE, PS, ZC | $\mathrm{V}_{\text {H }}$ |  | $\begin{gathered} \operatorname{Vcc} \times \\ 0.7 \end{gathered}$ | - | - | V |
|  |  | VIL |  | - | - | $\begin{gathered} \operatorname{Vcc} \times \\ 0.3 \end{gathered}$ |  |
| Input current | Data, Clock, LE, PS | І ${ }_{\text {H }}$ |  | -1.0 | - | +1.0 | $\mu \mathrm{A}$ |
|  |  | ILL |  | -1.0 | - | +1.0 |  |
|  | ZC | Ін |  | -1.0 | - | +1.0 | $\mu \mathrm{A}$ |
|  |  | ILL | Pull up input | -100 | - | 0 |  |
|  | OSCin | $\mathrm{IH}^{\text {H}}$ |  | 0 | - | +100 | $\mu \mathrm{A}$ |
|  |  | ILL |  | -100 | - | 0 |  |
| Output voltage | фP | VoL | Open drain output | - | - | 0.4 | V |
|  | фR, LD/fout | Vон |  | $\begin{gathered} \text { Vcc- } \\ 0.4 \end{gathered}$ | - | - | V |
|  |  | VoL |  | - | - | 0.4 |  |
|  | Do | Vooh |  | $\begin{gathered} \text { Vp- } \\ 0.4 \end{gathered}$ | - | - | V |
|  |  | Vool |  | - | - | 0.4 |  |
| High impedance cutoff current | Do | loff |  | - | - | 1.1 | $\mu \mathrm{A}$ |
| Output current | $\phi \mathrm{P}$ | lo | Open drain output | - | - | 1.0 | mA |
|  | $\phi$ R, LD/fout | Іон |  | - | - | -1.0 | mA |
|  |  | loL |  | 1.0 | - | - |  |
|  | Do | Ioon | $\begin{aligned} & \mathrm{Vcc}=3.0 \mathrm{~V}, \\ & \mathrm{Vp}=5 \mathrm{~V}, \\ & \mathrm{VooH}=4.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C} \end{aligned}$ | - | -10.0 | - | mA |
|  |  | Iool | $\begin{aligned} & \mathrm{V} \mathrm{cc}=3.0 \mathrm{~V}, \\ & \mathrm{Vp}=5 \mathrm{~V}, \\ & \mathrm{~V} \text { DoL }=1.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C} \end{aligned}$ | - | 10.0 | - |  |

*1: Conditions; $\mathrm{Vcc}=3.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$, in locking state.

## FUNCTION DESCRIPTIONS

## Pulse Swallow Function

The divide ratio can be calculated using the following equation:

```
fvco = [(P x N) + A] x fosc % R (A<N)
    fvco : Output frequency of external voltage controlled oscillator (VCO)
    N : Preset divide ratio of binary 11-bit programmable counter (5 to 2,047)
    A : Preset divide ratio of binary 7-bit swallow counter ( 0 < A < 127)
    fosc : Output frequency of the reference frequency oscillator
    R : Preset divide ratio of binary 14-bit programmable reference counter (5 to 16,383)
    P : Preset divide ratio of modules prescaler (32 or 64)
```


## Serial Data Input

Serial data is processed using the Data, Clock, and LE pins. Serial data controls the programmable reference divider and the programmable divider separately.
Binary serial data is entered through the Data pin.
One bit of data is shifted into the shift register on the rising edge of the clock. When the load enable pin is high, stored data is latched according to the control bit data as follows:

Table. 1 Control Bit

| Control bit (CNT) | Destination of serial data |
| :---: | :--- |
| H | 17 bit latch (for the programmable reference divider) |
| L | 18 bit latch (for the programmable divider) |

## Shift Register Configuration

## Programmable Reference Counter



CNT
: Control bit
R1 to R14 : Divide ratio setting bit for the programmable reference counter (5 to 16,383 )
SW : Divide ratio setting bit for the prescaler (32/33 or 64/65)
FC : Phase control bit for the phase comparator
LDS : LD/fout signal select bit
[Table. 1]
[Table. 2]
[Table. 5]
[Table. 7]
[Table. 6]

Note : Start data input with MSB first

Programmable Reference Counter


Note : Start data input with MSB first

Table2. Binary 14-bit Programmable Reference Counter Data Setting

| Divide <br> ratio <br> $\mathbf{( R )}$ | $\mathbf{R}$ <br> $\mathbf{1 4}$ | $\mathbf{R}$ <br> $\mathbf{1 3}$ | $\mathbf{R}$ <br> $\mathbf{1 2}$ | $\mathbf{R}$ <br> $\mathbf{1 1}$ | $\mathbf{R}$ <br> $\mathbf{1 0}$ | $\mathbf{R}$ <br> $\mathbf{9}$ | $\mathbf{R}$ <br> $\mathbf{8}$ | $\mathbf{R}$ <br> $\mathbf{7}$ | $\mathbf{R}$ <br> $\mathbf{6}$ | $\mathbf{R}$ <br> $\mathbf{5}$ | $\mathbf{R}$ <br> $\mathbf{4}$ | $\mathbf{R}$ <br> $\mathbf{3}$ | $\mathbf{R}$ <br> $\mathbf{2}$ | $\mathbf{R}$ <br> $\mathbf{1}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 5 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 |
| 6 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 |
| $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ |
| 16383 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |

Note: • Divide ratio less than 5 is prohibited.
Table. 3 Binary 11-bit Programmable Counter Data Setting

| Divide <br> ratio <br> (N) | $\mathbf{N}$ <br> $\mathbf{1 1}$ | $\mathbf{N}$ <br> $\mathbf{1 0}$ | $\mathbf{N}$ <br> $\mathbf{9}$ | $\mathbf{N}$ <br> $\mathbf{8}$ | $\mathbf{N}$ <br> $\mathbf{7}$ | $\mathbf{N}$ <br> $\mathbf{6}$ | $\mathbf{N}$ <br> $\mathbf{5}$ | $\mathbf{N}$ <br> $\mathbf{4}$ | $\mathbf{N}$ <br> $\mathbf{3}$ | $\mathbf{N}$ <br> $\mathbf{2}$ | $\mathbf{N}$ <br> $\mathbf{1}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 5 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 |
| 6 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 |
| $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ |
| 2047 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |

Note: • Divide ratio less than 5 is prohibited.

- Divide ratio ( N ) range $=5$ to 2,047

Table. 4 Binary 7-bit Swallow Counter Data Setting

| Divide <br> ratio <br> (A) | $\mathbf{A}$ <br> $\mathbf{7}$ | $\mathbf{A}$ <br> $\mathbf{6}$ | $\mathbf{A}$ <br> $\mathbf{5}$ | $\mathbf{A}$ <br> $\mathbf{4}$ | $\mathbf{A}$ <br> $\mathbf{3}$ | $\mathbf{A}$ <br> $\mathbf{2}$ | $\mathbf{A}$ <br> $\mathbf{1}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| • | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ | $\cdot$ |
| 127 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |

Note: • Divide ratio (A) range $=0$ to 127
Table. 5 Prescaler Data Setting

| SW | Prescaler Divide ratio |
| :---: | :---: |
| H | $32 / 33$ |
| L | $64 / 65$ |

Table. 6 LD/fout Output Select Data Setting

| LDS | LD/fout output signal |
| :---: | :--- |
| H | fout signal |
| L | LD signal |

## Relation between the FC input and phase characteristics

The FC bit changes the phase characteristics of the phase comparator. Both the internal charge pump output level ( $\mathrm{D} \circ$ ) and the phase comparator output ( $\phi \mathrm{R}, \phi \mathrm{P}$ ) are reversed according to the FC bit. Also, the monitor pin (fout) output is controlled by the FC bit. The relationship between the FC bit and each of $D o, \phi R$, and $\phi P$ is shown below.

Table. 7 FC Bit Data Setting (LDS = "H")

|  | FC = High |  |  |  | FC = Low |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Do | $\phi R$ | $\phi P$ | LD/fout | Do | $\phi R$ | $\phi P$ | LD/fout |
| $\mathrm{f}_{\mathrm{r}}>\mathrm{f}_{\mathrm{p}}$ | H | L | L | $(\mathrm{fr})$ | L | H | $\mathrm{Z}^{*}$ | $(\mathrm{fp})$ |
| $\mathrm{fr}_{\mathrm{r}}<\mathrm{f}_{\mathrm{p}}$ | L | H | $\mathrm{Z}^{*}$ | $(\mathrm{fr})$ | H | L | L | $(\mathrm{fp})$ |
| $\mathrm{f}_{\mathrm{r}}=\mathrm{f}_{\mathrm{p}}$ | $\mathrm{Z}^{*}$ | L | $\mathrm{Z}^{*}$ | $(\mathrm{fr})$ | $\mathrm{Z}^{*}$ | L | $\mathrm{Z}^{*}$ | $(\mathrm{fp})$ |

[^0]When designing a synthesizer, the FC pin setting depends on the VCO and LPF characteristics.
*: When the LPF and VCO characteristics are similar to ${ }^{(1)}$, set FC bit high.
*: When the VCO characteristics are similar to (2), set FC bit low.



## Power Saving Mode (Intermittent Mode Control Circuit)

Setting a PS pin to Low, the IC enters into power saving mode resultatly current sonsumption can be limited to $10 \mu \mathrm{~A}$ (max.). Setting PS pin to High, power saving mode is released so that the IC works normally.
In addition, the intermittent operation control circuit is included which helps smooth start up from the power saving mode. In general, the power consumption can be saved by the intermittent operation that powering down or waking up the synthesizer. Such case, if the PLL is powered up uncontrolled, the resulting phase comparator output signal is unpredictable due to an undefined phase relation between reference frequency ( $\mathrm{f}_{\mathrm{r}}$ ) and comparison frequency ( $f_{p}$ ) and may in the worst case take longer time for lock up of the loop.
To prevent this, the intermittent operation control circuit enforces a limited error signal output of the phase detector during power up, thus keeping the loop locked.
During the power saving mode, the corresponding section except for indispensable circuit for the power saving function stops working, then current consumption is reduced to $10 \mu \mathrm{~A}$ (max.).
At that time, the Do and LD become the same state as when a loop is locking. That is, the Do becomes high impedance.
A VCO control voltage is naturally kept at the locking voltage which defined by a LPF"s time constant. As a result of this, VCO's frequency is kept at the locking frequency.

Note: • While the power saving mode is executed, ZC pin should be set at " $H$ " or open. If ZC is set at " $L$ " during power saving mode, approximately $10 \mu \mathrm{~A}$ current flows.

- PS pin must be set "L" at Power-ON.
- The power saving mode can be released (PS : $L \rightarrow H$ ) 1 us later after power supply remains stable.
- During the power saving mode, it is possible to input the serial data.

Table. 8 PS Pin Setting

| PS pin | Status |
| :---: | :--- |
| H | Normal mode |
| L | Power saving mode |

Table. 9 ZC Pin Setting

| ZC pin | Do output |
| :---: | :--- |
| $H$ | Normal output |
| L | High impedance |

## SERIAL DATA INPUT TIMING



On rising edge of the clock, one bit of the data is transferred into the shift register.

| Parameter | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: |
| t1 | 20 | - | - | ns |
| t2 | 20 | - | - | ns |
| t3 | 30 | - | - | ns |
| t4 | 30 | - | - | ns |


| Parameter | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: |
| t5 | 100 | - | - | ns |
| t6 | 20 | - | - | ns |
| t 7 | 100 | - | - | ns |
|  |  |  |  |  |

## PHASE COMPARATOR OUTPUT WAVEFORM


[ FC = "H"]

[ FC = "L"]


Notes: 1. Phase error detection range: $-2 \pi t \mathrm{to}+2 \pi$
2. Pulses on Do output signal during locked state are output to prevent dead zone.
3. LD output becomes low when phase is twu or more. L.D output becomes high when phase error is twL or less and continues to be so for three cysles or more.
4. twu and twL depend on OSCin input frequency.
twu $\geq 8 /$ fosc (e g.twu $\geq 625 \mathrm{~ns}$, foscin $=12.8 \mathrm{MHz}$ )
$\mathrm{twL} \leq 16 / \mathrm{fosc}$ (e g.twl $\leq 1250 \mathrm{~ns}$, foscin $=12.8 \mathrm{MHz}$ )
5. LD becomes high during the power saving mode ( $\mathrm{PS}=\mathrm{L} \mathrm{L} "$.)

## MB15E07

## TEST CIRCUIT (for Measuring Input Sensitivity fin/OSCin)



## APPLICATION EXAMPLE


(Continued)

## TYPICAL CHARACTERISTICS

## Do Output Current



fin Input Sensitivity

(Continued)

## MB15E07

(Continued)
fin Input Snsitivity


OSCin Input Characteristics

(Continued)
(Continued)

## fin Input Impedance



OSCin Input Impedance


## MB15E07

## REFERENCE INFORMATION


(Continued)


## MB15E07

■ ORDERING INFORMATION

| Part number | Package | Remarks |
| :---: | :---: | :---: |
| MB15E07PFV1 | 16-pin Plastic SSOP <br> (FPT-16P-M05) |  |

## MB15E07

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[^0]:    *:High impedance

